

DATASHEET

SMD • B 12-22/BHR6C-A01/2C



香港至恩科技有限公司 www.to-grace.com 公司授权代理销售LITE-ON:光耦,贴片LED灯等 进口原装,现货供应,价格优势,技术支持 电话:0755-83464948 传真:0755-83464076

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Description

- The 12-22 SMD LED is much smaller than lead frame type components, thus enable smaller board ize, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.



Device Selection Guide

Chip		Emittad Color	Resin Color		
Type	Materials	Emitted Color	Resili Coloi		
ВН	InGaN	Blue	Water Clear		
R6	AlGaInP	Brilliant Red	Water Clear		

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V _R	5	V	
Forward Current	l _F	BH: 25 R6: 25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	BH: 100 R6: 60	mA	
Power Dissipation	Pd	BH: 95 R6: 60	mW	
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\! \mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge	ESD _{HBM}	BH: 150 R6: 2000	V	
Soldering Temperature	T _{sol}	Reflow Soldering : 260 $^{\circ}\mathbb{C}$ for 30 sec. Hand Soldering : 350 $^{\circ}\mathbb{C}$ for 3 sec.		



Electro-Optical Characteristics (Ta=25°C)

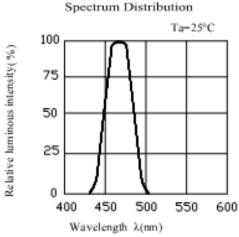
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv BH R6	18.0 22.5	28.0 30.0		mcd	I _F =5mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =5mA
Peak Wavelength	λρ BH R6		468 632		nm	I _F =5mA
Dominant Wavelength	λd BH R6		470 624		nm	I _F =5mA
Spectrum Radiation Bandwidth	△λ BH R6		25 20		nm	I _F =5mA
Forward Voltage	V _F BH R6	2.7 1.7		3.1 2.2	V	I _F =5mA
Reverse Current	l _R BH R6			50 10	μΑ	V _R =5V

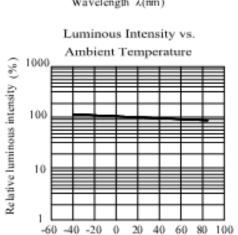
Note:

^{1.} Tolerance of Luminous Intensity: ±11%

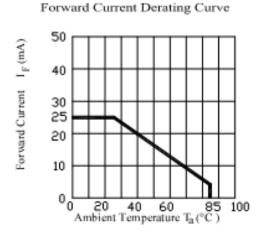
^{2.} Tolerance of Forward Voltage ±0.05V

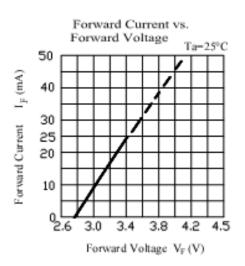
Typical Electro-Optical Characteristics Curves BH

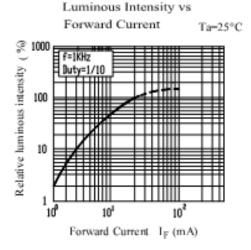


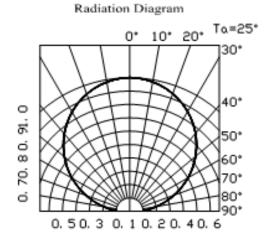


Ambient Temperature T_a(°C)



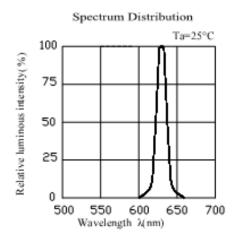


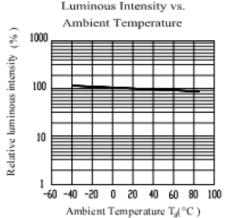


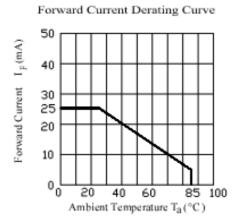


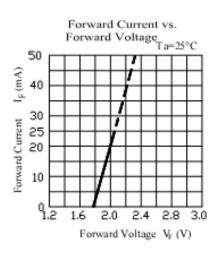


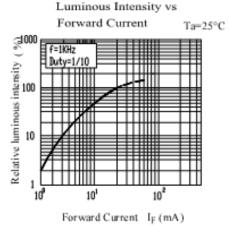
Typical Electro-Optical Characteristics Curves R6

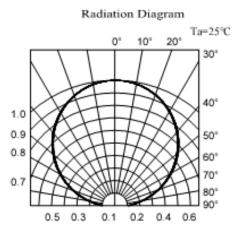




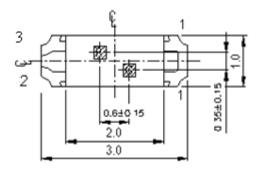


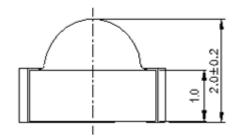


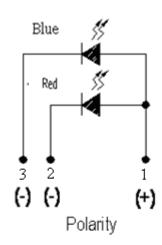




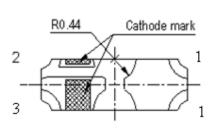
Package Dimension

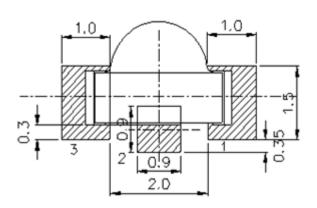






For reflow soldering (propose)



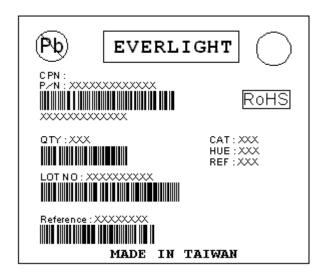


Note: Tolerances unless mentioned ±0.1mm. Unit = mm Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.



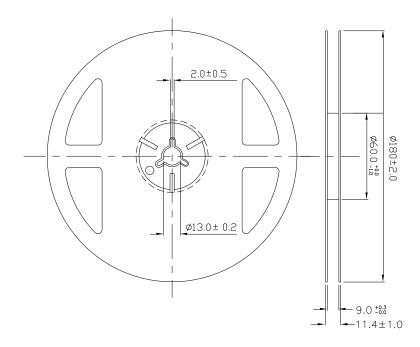
Moisture Resistant Packing Materials

Label Explanation



- CAT: Luminous Intensity Rank
- HUE: Dom.Wavelength Rank
- REF: Forward Voltage Rank

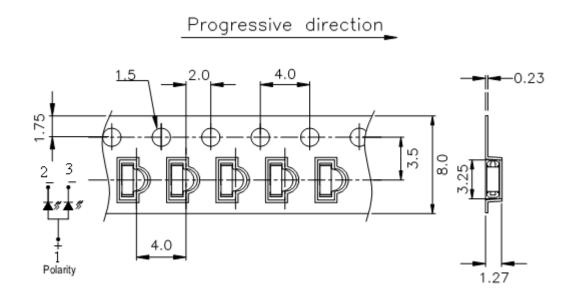
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

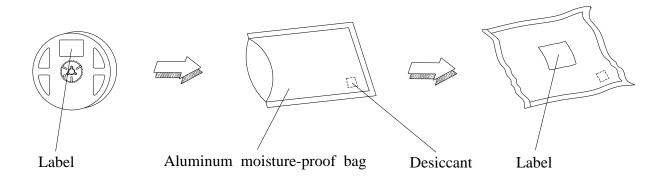


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

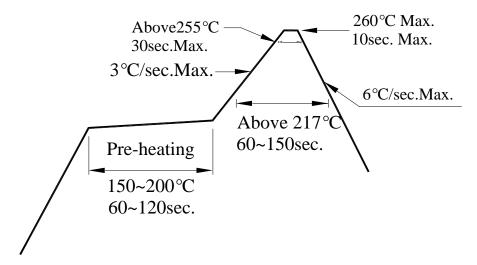
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less.

 If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



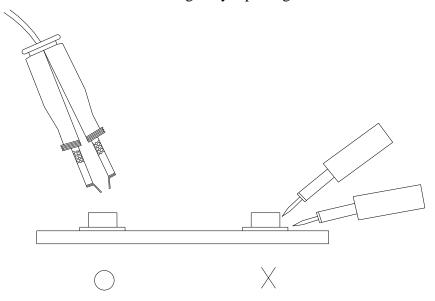
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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